

# C3M0016120D

## Silicon Carbide Power MOSFET C3M<sup>™</sup> MOSFET Technology

N-Channel Enhancement Mode

#### Features

- C3M<sup>™</sup> Silicon Carbide (SiC) MOSFET technology
- High blocking voltage with low On-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q<sub>rr</sub>)
- Halogen free, RoHS compliant



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Part Number	Package	Marking
C3M0016120D	TO 247-3	C3M0016120D

### Applications

- Renewable energy
- High voltage DC/DC converters
- Switch Mode Power Supplies
- UPS

#### Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency

#### **Key Parameters**

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V <sub>DS</sub>			1200	N	T <sub>c</sub> = 25°C	
Maximum Gate - Source Voltage	V <sub>GS(max)</sub>			+19	V	Transient	
Operational Gate-Source Voltage	V <sub>GS op</sub>		-4/15			Static	Note 1
DC Continuous Drain Current				115		$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 25 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	Fig. 19
	I <sub>D</sub>			85	А	$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 100 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	Note 2
Pulsed Drain Current	I <sub>DM</sub>			250		$t_{Pmax}$ limited by $T_{jmax}$ $V_{GS} = 15V, T_{C} = 25 \text{ °C}$	Fig. 22
Power Dissipation	P <sub>D</sub>			556	w	$T_{c} = 25^{\circ}C, T_{J} = 175^{\circ}C$	Fig. 20
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>			-40 to +175	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	
Mounting Torque	M <sub>D</sub>			1 8.8	Nm Ibf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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## **Electrical Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	1200	_	_		$V_{GS} = 0 V$ , $I_D = 100 \mu A$	
	N	1.8	2.5	3.6	V	$V_{DS} = V_{GS}, I_D = 23 \text{ mA}$	- Fig. 11
Gate Threshold Voltage	$V_{GS(th)}$	_	2.0	_		$V_{DS} = V_{GS}$ , $I_D = 23$ mA, $T_J = 175$ °C	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	1	50	μA	$V_{DS} = 1200 \text{ V}, V_{GS} = 0 \text{ V}$	
Gate-Source Leakage Current	I <sub>GSS</sub>	_	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$	
Drain Source On State Desistence	D	11.2	16	22.3		$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 75 \text{ A}$	Fig. 4, 5, 6
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	_	28.8	_	mΩ	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 75 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	
Tanana da atau ar	_		53		6	$V_{DS} = 20 \text{ V}, I_{DS} = 75 \text{ A}$	Fig. 7
Transconductance	g <sub>fs</sub>	_	47	] —	S	$V_{DS} = 20 \text{ V}, \text{ I}_{DS} = 75 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	
Input Capacitance	C <sub>iss</sub>	_	6085	_		$V_{GS} = 0 V$ ,	
Output Capacitance	Coss	_	230	_	pF	$V_{GS} = 0 V,$ $V_{DS} = 1000 V$	Fig. 17, 18
Reverse Transfer Capacitance	C <sub>rss</sub>	_	13	_	1	f = 100  khz	
Coss Stored Energy	E <sub>oss</sub>	_	130	_	μJ	$V_{AC} = 25 \text{ mV}$	Fig. 16
Turn-On Switching Energy (Body Diode)	Eon	_	4.64	_			
Turn Off Switching Energy (Body Diode)	E <sub>off</sub>	_	2.93	_		$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = -4/+15 \text{ V}, \text{ I}_{D} = 75 \text{ A},$	
Turn-On Switching Energy (External Diode)	Eon	_	7.79	_	$= mJ \qquad R_{G(ext)} = 5\Omega, L = 65.7 \mu\text{H}, T_J = 175^{\circ}\text{C}$		Fig. 25
Turn Off Switching Energy (External Diode)	E <sub>off</sub>	_	2.95	_	1		
Turn-On Delay Time	t <sub>d(on)</sub>	_	174	_			
Rise Time	tr	_	28	_	ns $V_{DS} = 800 \text{ V}, V_{GS} = -4/25 \text{ V}$ $R_{G(ext)} = 5 \Omega, I_D = 75 \text{ A}, L = 65.7 \mu\text{H}$ Timing relative to $V_{DS}$ , Inductive loa		Fig. 27
Turn-Off Delay Time	t <sub>d(off)</sub>	_	84	_			
Fall Time	t <sub>f</sub>	_	27	_			
Internal Gate Resistance	R <sub>G(int)</sub>	_	2.6	_	Ω	$f = 1 \text{ MHz}, V_{AC} = 25 \text{ mV}$	
Gate to Source Charge	Q <sub>gs</sub>	_	70	_		$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/25 \text{ V}$	
Gate to Drain Charge	Q <sub>gd</sub>	_	60	-	nC	$I_{\rm D} = 75 {\rm A}$	Fig. 12
Total Gate Charge	Qg	_	207	-		Per IEC60747-8-4 pg 21	



## **Reverse Diode Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Note
Diode Forward Voltage	N	4.6	-	v	$V_{GS} = -4 V$ , $I_{SD} = 37.5 A$ , $T_{J} = 25^{\circ}C$	Fig.
	V <sub>SD</sub>	4.2	-		$V_{GS} = -4 V$ , $I_{SD} = 37.5 A$ , $T_{J} = 175^{\circ}C$	8, 9, 10
Continuous Diode Forward Current	ls	-	112		$V_{GS} = -4 V, T_{C} = 25^{\circ}C$	
Diode Pulse Current	I <sub>S, pulsed</sub>	_	250	A	$V_{GS} = -4 V$ , pulse width t <sub>P</sub> limited by $T_{j max}$	
Reverse Recover Time	t <sub>rr</sub>	96	-	nS		
Reverse Recovery Charge	Q <sub>rr</sub>	604	-	nC	$V_{GS} = -4 V, I_{SD} = 75 A, V_{R} = 800 V$ $di_{F}/dt = 900, A/\mu s, T_{J} = 175^{\circ}C$	
Peak Reverse Recovery Current	I <sub>rrm</sub>	15	-	A	αιματ – 500, γγμ3, τj – 115 C	
Reverse Recovery time	t <sub>rr</sub>	58	-	nS		
Reverse Recovery Charge	Q <sub>rr</sub>	672	-	nC	$V_{GS} = -5 V, I_{SD} = 75 A, V_{R} = 800 V$ $di_{F}/dt = 1400 A/\mu s, T_{J} = 175^{\circ}C$	
Peak Reverse Recovery Current	I <sub>rrm</sub>	22	-	A	- αιματ - 1400 Λ/μ3, 13 - 173 C	

## **Thermal Characteristics**

Parameter	Symbol	Тур.	Unit	Note
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	0.27	8C (M)	<b>Fig. 21</b>
Thermal Resistance from Junction to Ambient	R <sub>0JA</sub>	40	°C/W	Fig. 21



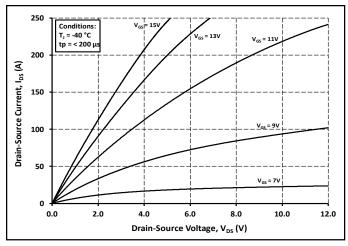


Figure 1. Output Characteristics T<sub>J</sub> = -40°C

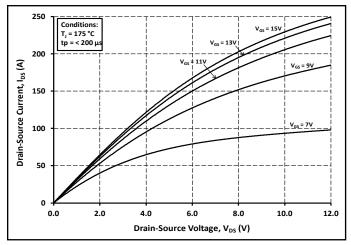
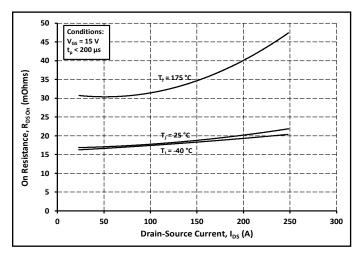
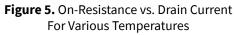


Figure 3. Output Characteristics T<sub>J</sub> = 175°C





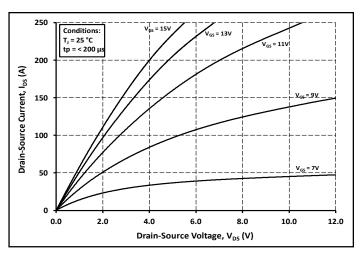


Figure 2. Output Characteristics  $T_J = 25^{\circ}C$ 

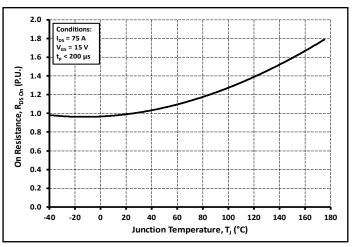


Figure 4. Normalized On-Resistance vs. Temperature

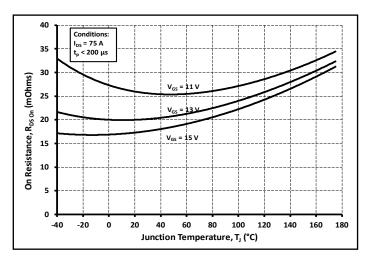
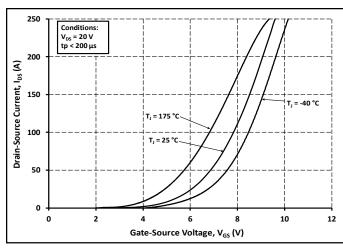


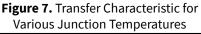
Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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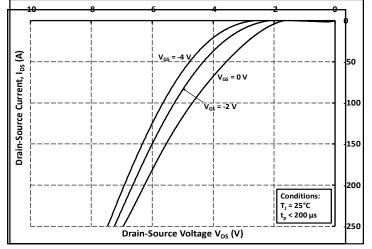
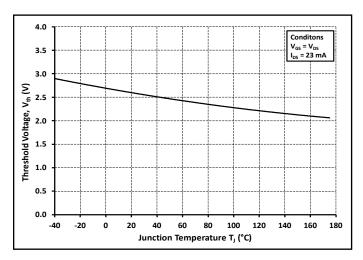
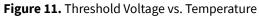


Figure 9. Body Diode Characteristic at 25°C





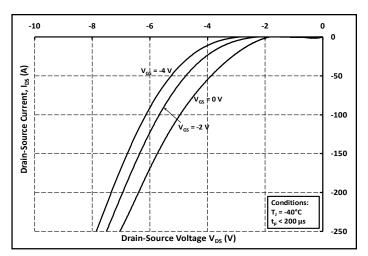


Figure 8. Body Diode Characteristic at -40°C

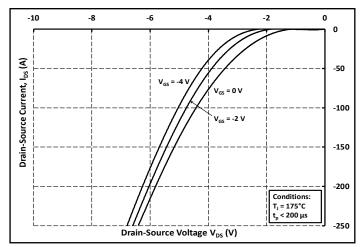


Figure 10. Body Diode Characteristic at 175°C

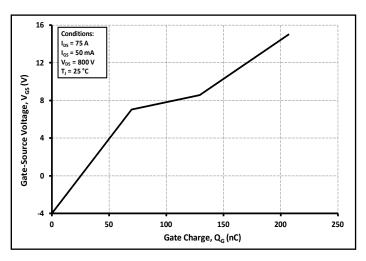


Figure 12. Gate Charge Characteristics

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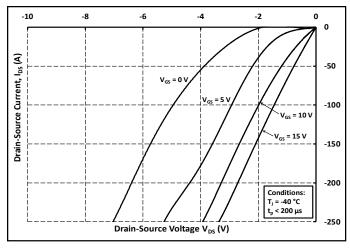


Figure 13. 3rd Quadrant Characteristic at -40°C

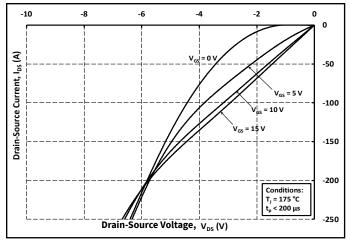
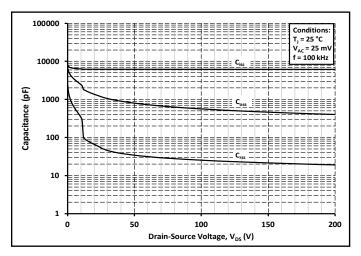
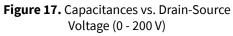


Figure 15. 3rd Quadrant Characteristic at 175°C





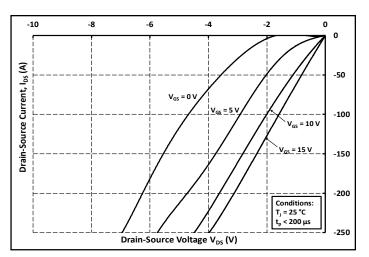


Figure 14. 3rd Quadrant Characteristic at 25°C

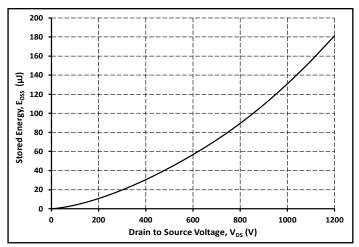
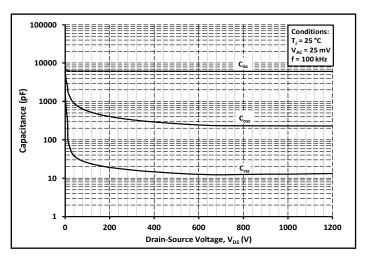
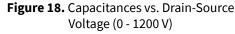


Figure 16. Output Capacitor Stored Energy

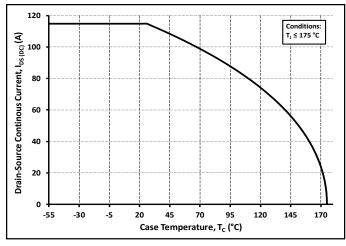


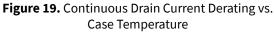


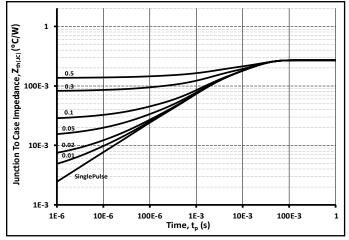
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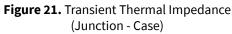
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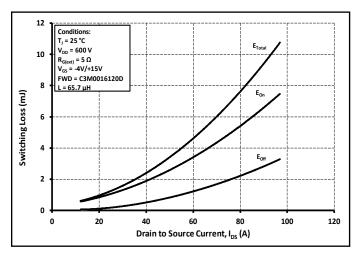


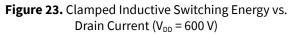












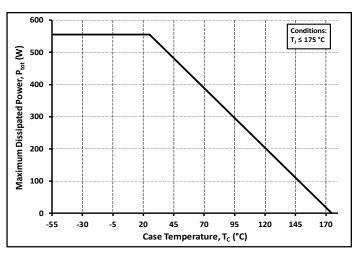


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

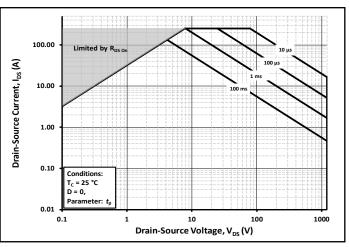
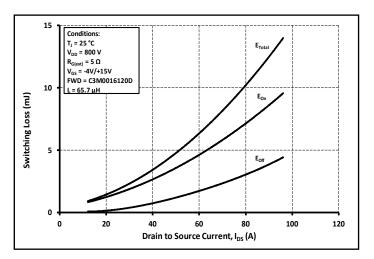


Figure 22. Safe Operating Area



**Figure 24.** Clamped Inductive Switching Energy vs. Drain Current (V<sub>DD</sub> = 800 V)

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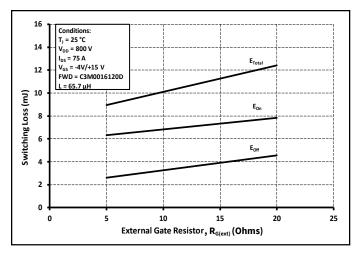


Figure 25. Clamped Inductive Switching Energy vs.  $\mathsf{R}_{\!\mathsf{G}(ext)}$ 

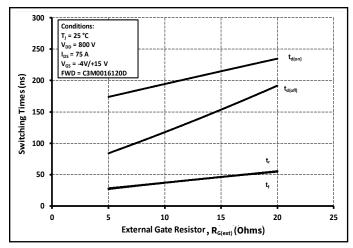


Figure 27. Switching Times vs.  $R_{G(ext)}$ 

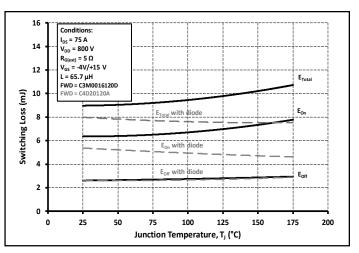


Figure 26. Clamped Inductive Switching Energy vs. Temperature

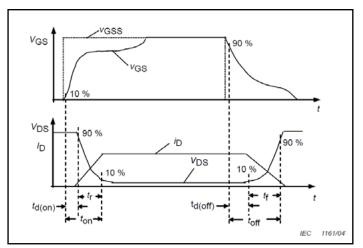


Figure 28. Switching Times Definition

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## **Test Circuit Schematic**

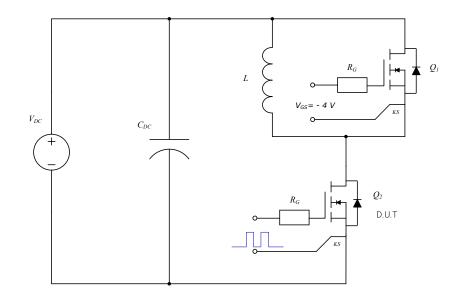


Figure 29. Clamped Inductive Switching Waveform Test Circuit

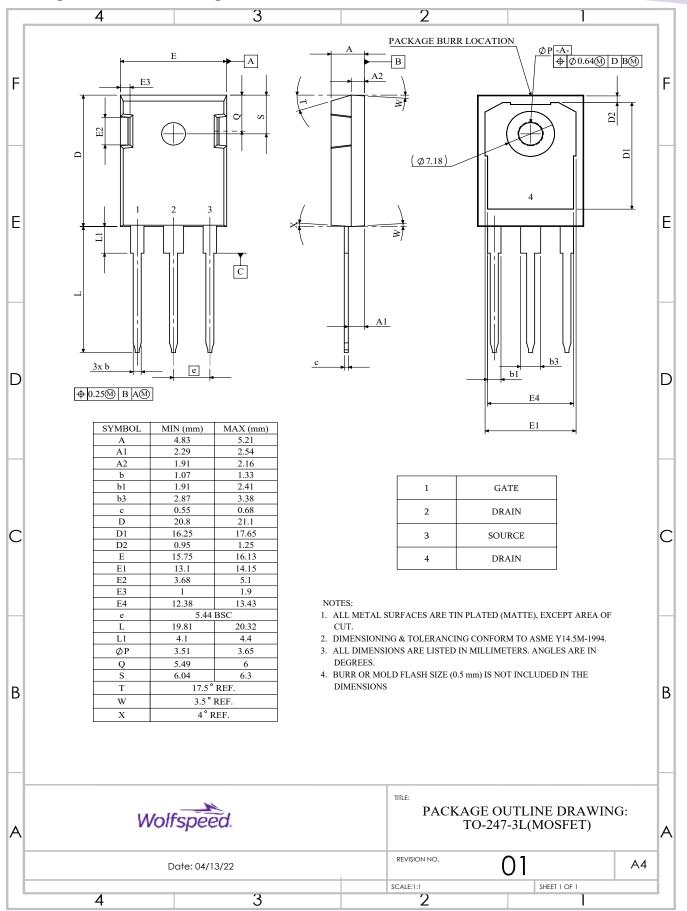
#### Note:

<sup>3</sup> Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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#### Package Dimensions - Package TO-247-3

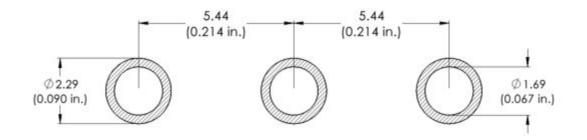


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## **Recommended Solder Pad Layout**



### **Revision History**

Current Revision	Date of Release	Description of Changes
-	August-2019	N/A
1	January-2024	Updated Wolfspeed branding, package drawing, package image, and solder pad layout, added Revision History Table, Table 1 layout revised

### **Related Links**

- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

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The Silicon Carbide MOSFET module switches at speeds beyond what is customarily associated with IGBT-based modules. Therefore, special precautions are required to realize optimal performance. The interconnection between the gate driver and module housing needs to be as short as possible. This will afford optimal switching time and avoid the potential for device oscillation. Also, great care is required to insure minimum inductance between the module and DC link capacitors to avoid excessive VDS overshoot.

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed.com.

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